



Product Summary

BV _{DSS}	Rds(on) Max	I _D Max T _A = +25°C
-60V	115mΩ @ V _{GS} = -10V	-2.7A
-6UV	145mΩ @ V _{GS} = -4.5V	-2.5A

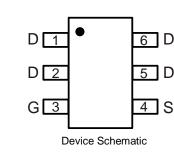
Description and Applications

This MOSFET is designed to minimize the on-state resistance $(R_{DS(ON)})$ yet maintain superior switching performance, making it ideal for high-efficiency power-management applications.

TSOT26

Top View

- Backlighting
- Power-management functions
- DC-DC converters



G Equivalent Circuit

Ordering Information (Note 4)

Part Number	Baakaga	Packing		
Fait Nulliber	Package	Qty.	Carrier	
DMP6111SVT-7	TSOT26	3,000	Tape & Reel	
DMP6111SVT-13	TSOT26	10,000	Tape & Reel	

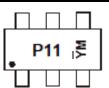
Notes: 1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant.

2. See https://www.diodes.com/quality/lead-free/ for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.

3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.

4. For packaging details, go to our website at https://www.diodes.com/design/support/packaging/diodes-packaging/.

Marking Information



P11 = Product Type Marking Code $\overline{Y}M$ = Date Code Marking \overline{Y} = Year (ex: K = 2023)

M = Month (ex: 8 = August)

Date Code Key												
Year	2023	2024	2025	2026	2027	2028	2029	2030	2031	2032	2033	2034
Code	K	L	М	N	Р	R	S	Т	U	V	W	Х
Month	Jan	Feb	Mar	Apr	Мау	Jun	Jul	Aug	Sep	Oct	Nov	Dec
Code	1	2	3	4	5	6	7	8	9	0	N	D

DMP6111SVT Document number: DS45985 Rev. 2 - 2

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60V P-CHANNEL ENHANCEMENT MODE MOSFET

Features and Benefits

- 100% Unclamped Inductive Switch (UIS) Test in Production
- Low On-Resistance
- Low Input Capacitance
- Fast Switching Speed
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- This part is qualified to JEDEC standards (as references in AEC-Q) for High Reliability.

https://www.diodes.com/quality/product-definitions/

 An automotive-compliant part is available under separate datasheet (<u>DMP6111SVTQ</u>)

Mechanical Data

- Package: TSOT26
- Package Material: Molded Plastic, "Green" Molding Compound. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminal Connections Indicator: See Diagram
- Terminals: Finish Matte Tin Annealed over Copper Leadframe. Solderable per MIL-STD-202, Method 208 (£3)
- Weight: 0.008 grams (Approximate)



Maximum Ratings (@T_A = +25°C, unless otherwise specified.)

Characteristic		Symbol	Value	Unit
Drain-Source Voltage	Vdss	-60	V	
Gate-Source Voltage	Vgss	±20	V	
Continuous Drain Current (Note 5) VGs = -10V	ID	-2.7 -2.1	А	
Maximum Body Diode Forward Current (Note 5)	ls	-2.7	A	
Pulsed Drain Current (10µs Pulse, Duty Cycle = 1%)	Ідм	-19	A	
Pulsed Source Current (10µs Pulse, Duty Cycle = 1%)	lsм	-19	A	
Avalanche Current, L = 0.1mH	las	-18.4	A	
Repetitive Avalanche Energy, L = 0.1mH	E _{AS}	16.9	mJ	

Thermal Characteristics (@T_A = +25°C, unless otherwise specified.)

Characteristic		Symbol	Value	Unit
Total Power Dissipation (Note 6)		PD	1.1	W
Thermal Resistance, Junction to Ambient (Note 6)	Steady State	Reja	110	°C/W
Total Power Dissipation (Note 5)		PD	1.6	W
Thermal Resistance, Junction to Ambient (Note 5)	Steady State	Reja	78	80 AM
Thermal Resistance, Junction to Case (Note 5)	Steady State	Rejc	8.2	°C/W
Operating and Storage Temperature Range		TJ, TSTG	-55 to +150	°C

Electrical Characteristics (@T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition	
OFF CHARACTERISTICS (Note 7)							
Drain-Source Breakdown Voltage	BV _{DSS}	-60			V	Vgs = 0V, ID = -250µA	
Zero Gate Voltage Drain Current	IDSS	—	_	-1	μA	VDS = -60V, VGS = 0V	
Gate-Source Leakage	Igss	_	_	±100	nA	$V_{GS} = \pm 20V, V_{DS} = 0V$	
ON CHARACTERISTICS (Note 7)						•	
Gate Threshold Voltage	Vgs(th)	-1	_	-3	V	$V_{DS} = V_{GS}, I_D = -250 \mu A$	
Static Drain-Source On-Resistance	P		87	115		$V_{GS} = -10V, I_D = -3A$	
Static Drain-Source On-Resistance	R _{DS(ON)}	_	112	145	mΩ	V _{GS} = -4.5V, I _D =-3A	
Diode Forward Voltage	Vsd	_	-0.8	-1.2	V	Vgs = 0V, Is = -1A	
DYNAMIC CHARACTERISTICS (Note 8)						•	
Input Capacitance	Ciss	_	1283	—		$V_{DS} = -30V, V_{GS} = 0V$ f = 1.0MHz	
Output Capacitance	Coss	—	58	—	pF		
Reverse Transfer Capacitance	Crss	_	43	—		1 = 1.000112	
Gate Resistance	Rg	-	5.6	—	Ω	$V_{DS} = 0V, V_{GS} = 0V$ f = 1.0MHz	
Total Gate Charge (V _{GS} = -4.5V)	Qg	—	11.2	—			
Total Gate Charge (V _{GS} = -10V)	Qg	_	23.2	—	nC		
Gate-Source Charge	Qgs	—	3.7	—	nc	$V_{DS} = -30V, I_{D} = -3A$	
Gate-Drain Charge	Q _{gd}	_	4.2	—			
Turn-On Delay Time	t _{D(ON)}	_	5.1	—			
Turn-On Rise Time	tR	_	18.4	—		V _{GS} = -10V, V _{DS} = -30V	
Turn-Off Delay Time	tD(OFF)	_	41.6	—	ns	$R_{GEN} = 6\Omega, I_D = -3A$	
Turn-Off Fall Time	tF	_	22.7	_			
Reverse-Recovery Time	t _{RR}	_	23	—	ns	I _S = -3A, dI/dt = -100A/µs	
Reverse-Recovery Charge	Q _{RR}	_	20	_	nC	Is = -3A, dl/dt = -100A/µs	

Notes:

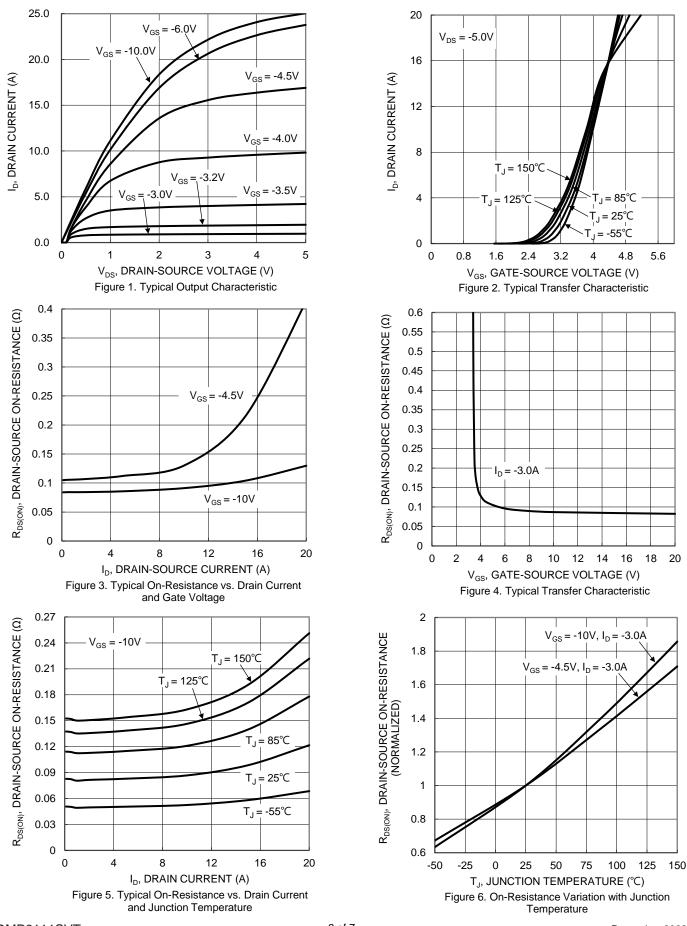
Device mounted on FR-4 substrate PC board, 2oz copper, with 1inch square copper plate.
Device mounted on FR-4 substrate PC board, 2oz copper, with minimum recommended pad layout.

7. Short duration pulse test used to minimize self-heating effect.

8. Guaranteed by design. Not subject to product testing.



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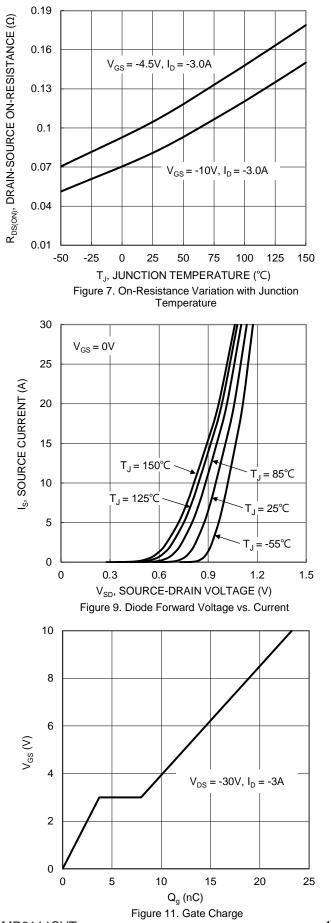


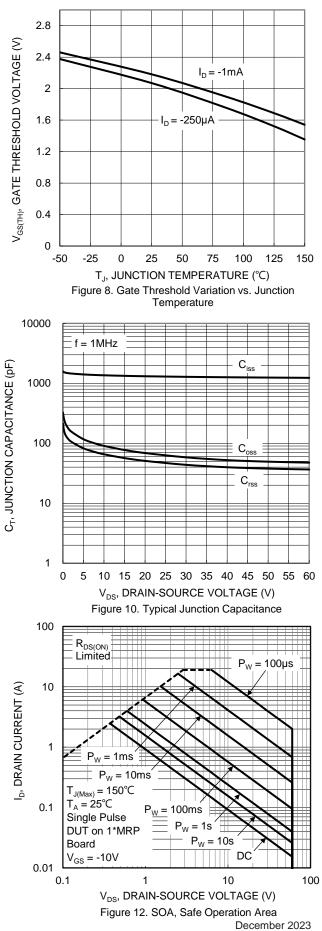
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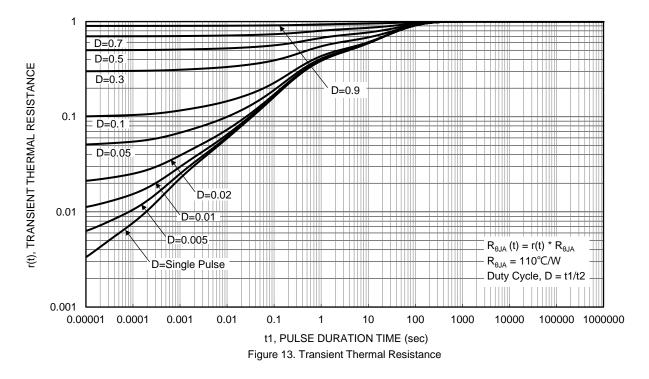


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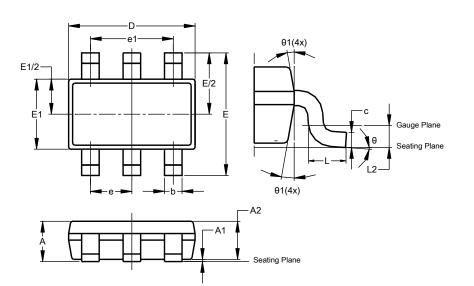






Package Outline Dimensions

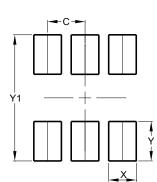
Please see http://www.diodes.com/package-outlines.html for the latest version.



TSOT26							
Dim	Min	Max	Тур				
Α	-	1.00	-				
A1	0.010	0.100	-				
A2	0.840	0.900	-				
D	2.800	3.000	2.900				
Е	2	.800 BS	С				
E1	1.500	1.700	1.600				
b	0.300	0.450	-				
С	0.120	0.200	-				
е	0.950 BSC						
e1	1	1.900 BSC					
L	0.30	0.50	-				
L2	0.250 BSC						
θ	0°	8°	4°				
θ1	4°	12°	_				
A	All Dimensions in mm						

Suggested Pad Layout

Please see http://www.diodes.com/package-outlines.html for the latest version.



TSOT26

TSOT26

Dimensions	Value (in mm)
С	0.950
Х	0.700
Y	1.000
Y1	3.200



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